

Complete Quad, 16-Bit, High Accuracy, Serial Input, Bipolar Voltage Output DAC

Enhanced Product

AD5764-EP

FEATURES

Complete quad, 16-bit digital-to-analog converter (DAC) Programmable output range: $\pm 10 V$, $\pm 10.2564 V$, or $\pm 10.5263 V$ $\pm 2 LSB$ maximum INL error, $\pm 1 LSB$ maximum DNL error Low noise: $60 nV/\sqrt{Hz}$ Settling time: $10 \mu s$ maximum Integrated reference buffers Output control during power-up/brownout Programmable short-circuit protection Simultaneous updating via LDAC Asynchronous CLR to zero code Digital offset and gain adjust Logic output control pins DSP-/microcontroller-compatible serial interface Temperature range: -55° C to $+105^{\circ}$ C *i*CMOS process technology¹

ENHANCED PRODUCT FEATURES

Supports defense and aerospace applications (AQEC standard) Extended temperature range: -55°C to +105°C Controlled manufacturing baseline One assembly/test site One fabrication site Enhanced product change notification Qualification data available on request

APPLICATIONS

Industrial automation Open-loop/closed-loop servo control Process control Data acquisition systems Automatic test equipment Automotive test and measurement High accuracy instrumentation

GENERAL DESCRIPTION

The AD5764-EP is a quad, 16-bit, serial input, bipolar voltage output DAC that operates from supply voltages of ± 11.4 V to ± 16.5 V. The nominal full-scale output range is ± 10 V. The AD5764-EP provides integrated output amplifiers, reference buffers, and proprietary power-up/power-down control circuitry. The device also features a digital I/O port that is programmed via the serial interface. The AD5764-EP incorporates digital offset and gain adjust registers per channel.

The AD5764-EP is a high performance converter that offers guaranteed monotonicity, integral nonlinearity (INL) of ± 2 LSB, low noise, and 10 μ s settling time. During power-up (when the supply voltages are changing), VOUTx is clamped to 0 V via a low impedance path.

The AD5764-EP uses a serial interface that operates at clock rates of up to 30 MHz and is compatible with DSP and microcontroller interface standards. Double buffering allows the simultaneous updating of all DACs. The input coding is programmable to either twos complement or offset binary format. The asynchronous clear function clears the data register to either bipolar zero or zero scale depending on the coding used. The AD5764-EP is ideal for both closed-loop servo control and open-loop control applications. The AD5764-EP is available in a 32-lead TQFP and offers guaranteed specifications over the -55° C to $+105^{\circ}$ C industrial temperature range. See Figure 1 for the functional block diagram.

Additional application and technical information can be found in the AD5764 data sheet.

Table 1. Related Devices

Part No.	Description
AD5764R	AD5764 with internal voltage reference
AD5744R	Complete quad, 14-bit, high accuracy, serial input, bipolar voltage output DAC with internal voltage reference

¹ For analog systems designers within industrial/instrumentation equipment OEMs who need high performance ICs at higher voltage levels, *i*CMOS[®] is a technology platform that enables the development of analog ICs capable of 30 V and operating at ±15 V supplies, allowing dramatic reductions in power consumption and package size, and increased ac and dc performance.

Rev. 0

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REVISION HISTORY

12/13—Revision 0: Initial Version

FUNCTIONAL BLOCK DIAGRAM



SPECIFICATIONS

 $AV_{DD} = 11.4 \text{ V}$ to 16.5 V, $AV_{SS} = -11.4 \text{ V}$ to -16.5 V, AGNDx = DGND = REFGND = PGND = 0 V; REFAB = REFCD = 5 V; $DV_{CC} = 2.7 \text{ V}$ to 5.25 V, $R_{LOAD} = 10 \text{ k}\Omega$, $C_{LOAD} = 200 \text{ pF}$. Temperature range: -55° C to $+105^{\circ}$ C; typical at $+25^{\circ}$ C. All specifications T_{MIN} to T_{MAX} , unless otherwise noted.

Table 2.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
ACCURACY					Outputs unloaded
Resolution	16			Bits	
Relative Accuracy (INL)			±2	LSB	
Differential Nonlinearity (DNL)			±1	LSB	Guaranteed monotonic
Bipolar Zero Error			±2	mV	At 25°C; error at other temperatures obtained using bipolar zero TC
Bipolar Zero Temperature Coefficient (TC) ¹			±2	ppm FSR/°C	
Zero-Scale Error			±3	mV	At 25°C; error at other temperatures obtained using zero-scale TC
Zero-Scale TC ¹			±2	ppm FSR/°C	
Gain Error			±0.02	% FSR	At 25°C; error at other temperatures obtained using gain TC
Gain TC ¹			±2	ppm FSR/°C	
DC Crosstalk ¹			0.5	LSB	
REFERENCE INPUT ¹					
Reference Input Voltage		5		V	±1% for specified performance
DC Input Impedance	1			MΩ	Typically 100 MΩ
Input Current			±10	μΑ	Typically ±30 nA
Reference Range	1		7	V	
OUTPUT CHARACTERISTICS ¹					
Output Voltage Range ²	-10.5263		+10.5263	V	$AV_{DD}/AV_{SS} = \pm 11.4 \text{ V}, V_{REFIN} = 5 \text{ V}$
	-14		+14	V	$AV_{DD}/AV_{SS} = \pm 16.5 \text{ V}, V_{REFIN} = 7 \text{ V}$
Output Voltage Drift vs. Time		±13		ppm FSR/ 500 hours	
		±15		ppm FSR/ 1000 hours	
Short-Circuit Current		10		mA	$R_{ISCC} = 6 k\Omega$; see Figure 31
Load Current			±1	mA	For specified performance
Capacitive Load Stability					
$R_{LOAD} = \infty$			200	pF	
$R_{LOAD} = 10 \ k\Omega$			1000	pF	
DC Output Impedance			0.3	Ω	
DIGITAL INPUTS					$D_{VCC} = 2.7 V$ to 5.25 V, JEDEC compliant
Input High Voltage, V⊩	2			V	
Input Low Voltage, V _⊫			0.8	V	
Input Current			±1	μΑ	Per pin
Pin Capacitance			10	pF	Per pin
DIGITAL OUTPUTS (D0, D1, SDO) ¹					
Output Low Voltage, Vol			0.4	V	$DV_{CC} = 5 V \pm 5\%$, sinking 200 μ A
			0.4	V	$D_{VCC} = 2.7 \text{ V}$ to 3.6 V, sinking 200 μ A
Output High Voltage, V _{OH}	DV _{cc} – 1			V	$DV_{CC} = 5 V \pm 5\%$, sourcing 200 μ A
	DV _{cc} – 0.5			V	$D_{VCC} = 2.7 \text{ V}$ to 3.6 V, sourcing 200 μ A
High Impedance Leakage Current			±1	μΑ	SDO only
High Impedance Output Capacitance		5		pF	SDO only

AD5764-EP

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
POWER REQUIREMENTS					
AV _{DD} /AV _{SS}	±11.4		±16.5	V	
DVcc	2.7		5.25	V	
Power Supply Sensitivity ¹					
$\Delta V_{OUT} / \Delta A V_{DD}$		-85		dB	
AIDD			3.75	mA/channel	Outputs unloaded
Alss			-3	mA/channel	Outputs unloaded
Dlcc			1.4	mA	$V_{IH} = DV_{CC}, V_{IL} = DGND, 750 \ \mu A \ typical$
Power Dissipation		275		mW	±12 V operation, output unloaded

 $^{\rm 1}$ Guaranteed by design and characterization; not production tested. $^{\rm 2}$ Output amplifier headroom requirement is 1.4 V minimum.

AC PERFORMANCE CHARACTERISTICS

 $AV_{DD} = 11.4 \text{ V}$ to 16.5 V, $AV_{SS} = -11.4 \text{ V}$ to -16.5 V, AGNDx = DGND = REFGND = PGND = 0 V; REFAB = REFCD = 5 V; $DV_{CC} = 2.7 V$ to 5.25 V, $R_{LOAD} = 10 k\Omega$, $C_{LOAD} = 200 pF$. All specifications T_{MIN} to T_{MAX} , unless otherwise noted.

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Parameter	Min	Тур	Мах	Unit	Test Conditions/Comments
DYNAMIC PERFORMANCE ¹					
Output Voltage Settling Time		8	10	μs	Full-scale step to ±1 LSB
		2		μs	512 LSB step settling
Slew Rate		5		V/µs	
Digital-to-Analog Glitch Energy		8		nV-sec	
Glitch Impulse Peak Amplitude			37	mV p-p	
Channel-to-Channel Isolation		80		dB	
DAC-to-DAC Crosstalk		8		nV-sec	
Digital Crosstalk		2		nV-sec	
Digital Feedthrough		2		nV-sec	Effect of input bus activity on DAC
					outputs
Output Noise					
0.1 Hz to 10 Hz		0.1		LSB p-p	
0.1 Hz to 100 kHz			45	μV rms	
1/f Corner Frequency		1		kHz	
Output Noise Spectral Density		60		nV/√Hz	Measured at 10 kHz
Complete System Output Noise Spectral		80		nV/√Hz	Measured at 10 kHz
Density ²					

¹ Guaranteed by design and characterization; not production tested.

² Includes noise contributions from integrated reference buffers, 16-bit DAC, and output amplifier.

TIMING CHARACTERISTICS

 $AV_{DD} = 11.4 \text{ V}$ to 16.5 V, $AV_{SS} = -11.4 \text{ V}$ to -16.5 V, AGNDx = DGND = REFGND = PGND = 0 V; REFAB = REFCD = 5 V; $DV_{CC} = 2.7 \text{ V}$ to 5.25 V, $R_{LOAD} = 10 \text{ k}\Omega$, $C_{LOAD} = 200 \text{ pF}$. All specifications T_{MIN} to T_{MAX} , unless otherwise noted.

Table 4.			
Parameter ^{1, 2, 3}	Limit at T _{MIN} , T _{MAX}	Unit	Description
t ₁	33	ns min	SCLK cycle time
t ₂	13	ns min	SCLK high time
t ₃	13	ns min	SCLK low time
t4	13	ns min	SYNC falling edge to SCLK falling edge setup time
t5 ⁴	13	ns min	24 th SCLK falling edge to SYNC rising edge
t ₆	90	ns min	Minimum SYNC high time
t7	2	ns min	Data setup time
t ₈	9	ns min	Data hold time
t9	1.7	µs min	SYNC rising edge to LDAC falling edge (all DACs updated)
	480	ns min	SYNC rising edge to LDAC falling edge (single DAC updated)
t ₁₀	17	ns min	LDAC pulse width low
t11	500	ns max	LDAC falling edge to DAC output response time
t ₁₂	10	µs max	DAC output settling time
t ₁₃	17	ns min	CLR pulse width low
t ₁₄	2	µs max	CLR pulse activation time
t ₁₅ ^{5, 6}	25	ns max	SCLK rising edge to SDO valid
t ₁₆	13	ns min	SYNC rising edge to SCLK falling edge
t ₁₇	2	µs max	\overline{SYNC} rising edge to DAC output response time ($\overline{LDAC} = 0$)
t ₁₈	170	ns min	LDAC falling edge to SYNC rising edge

¹ Guaranteed by design and characterization; not production tested.

 2 All input signals are specified with t_R = t_F = 5 ns (10% to 90% of DV_{cc}) and timed from a voltage level of 1.2 V.

³ See Figure 3, Figure 4, and Figure 5.

⁴ Standalone mode only.

⁵ Measured with the load circuit of Figure 2.

⁶ Daisy-chain mode only.



Figure 2. Load Circuit for SDO Timing Diagram

Timing Diagrams



Figure 4. Daisy-Chain Timing Diagram





ABSOLUTE MAXIMUM RATINGS

 $T_A = 25^{\circ}$ C, unless otherwise noted. Transient currents of up to 100 mA do not cause SCR latch-up.

Table 5.

Parameter	Rating
AV _{DD} to AGNDx, DGND	-0.3 V to +17 V
AV _{ss} to AGNDx, DGND	+0.3 V to -17 V
DV _{cc} to DGND	–0.3 V to +7 V
Digital Inputs to DGND	-0.3 V to DV _{cc} + 0.3 V or 7 V (whichever is less)
Digital Outputs to DGND	-0.3 V to DV _{CC} + 0.3 V
REFAB, REFCD to AGNDx, PGND	-0.3 V to AV _{DD} + 0.3 V
VOUTA, VOUTB, VOUTC, VOUTD to AGNDx	AVss to AVdd
AGNDx to DGND	–0.3 V to +0.3 V
Operating Temperature Range	
Industrial	–55°C to +105°C
Storage Temperature Range	–65°C to +150°C
Junction Temperature (TJ max)	150°C
32-Lead TQFP	
θ_{JA} Thermal Impedance	65°C/W
θ_{JC} Thermal Impedance	12°C/W
Lead Temperature	JEDEC industry standard
Soldering	J-STD-020

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Table 6. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	SYNC	Active Low Input. This pin is the frame synchronization signal for the serial interface. While SYNC is low, data is transferred in on the falling edge of SCLK.
2	SCLK	Serial Clock Input. Data is clocked into the input shift register on the falling edge of SCLK. This input operates at clock speeds up to 30 MHz.
3	SDIN	Serial Data Input. Data must be valid on the falling edge of SCLK.
4	SDO	Serial Data Output. This pin is used to clock data from the serial register in daisy-chain or readback mode.
5	CLR	Negative Edge Triggered Input. Asserting this pin sets the data register to 0x0000. This logic input has an internal pull-up device. Therefore, this pin can be left floating and defaults to a Logic 1 condition.
6	LDAC	Load DAC. This logic input is used to update the data register and, consequently, the analog outputs. When LDAC is tied permanently low, the addressed data register is updated on the rising edge of SYNC. If LDAC is held high during the write cycle, the DAC input shift register is updated, but the update of the output is delayed until the falling edge of LDAC. In this mode, all analog outputs can be updated simultaneously on the falling edge of LDAC pin must not be left unconnected.
7, 8	D0, D1	Digital I/O Port. These pins can be inputs or outputs that are configurable and readable over the serial interface. When configured as inputs, D0 and D1 have weak internal pull-ups to DV _{CC} . When configured as outputs, D0 and D1 are referenced by DV _{CC} and DGND.
9	RSTOUT	Reset Logic Output. This pin is the output from the on-chip voltage monitor and is used in the reset circuit. If desired, this pin can be used to control other system components.
10	RSTIN	Reset Logic Input. This input allows external access to the internal reset logic. Applying a Logic 0 to this input clamps the DAC outputs to 0 V. In normal operation, RSTIN should be tied to Logic 1. Register values remain unchanged.
11	DGND	Digital Ground.
12	DV _{cc}	Digital Supply Voltage (2.7 V to 5.25 V).
13, 31	AVDD	Positive Analog Supply Voltage (11.4 V to 16.5 V).
14	PGND	Ground Reference Point for the Analog Circuitry.
15, 30	AVss	Negative Analog Supply Voltage (-11.4 V to -16.5 V).
16	ISCC	Resistor Connection for Pin Programmable Short-Circuit Current. This pin is used with an optional external resistor to AGND to program the short-circuit current of the output amplifiers.
17	AGNDD	Ground Reference Pin for DAC D Output Amplifier.
18	VOUTD	Analog Output Voltage of DAC D. This buffered output has a nominal full-scale output range of ± 10 V. The output amplifier is capable of directly driving a 10 k Ω , 200 pF load.
19	VOUTC	Analog Output Voltage of DAC C. This buffered output has a nominal full-scale output range of ± 10 V. The output amplifier is capable of directly driving a 10 k Ω , 200 pF load.
20	AGNDC	Ground Reference Pin for DAC C Output Amplifier.

Pin No.	Mnemonic	Description
21	AGNDB	Ground Reference Pin for DAC B Output Amplifier.
22	VOUTB	Analog Output Voltage of DAC B. This buffered output has a nominal full-scale output range of ± 10 V. The output amplifier is capable of directly driving a 10 k Ω , 200 pF load.
23	VOUTA	Analog Output Voltage of DAC A. This buffered output has a nominal full-scale output range of ± 10 V. The output amplifier is capable of directly driving a 10 k Ω , 200 pF load.
24	AGNDA	Ground Reference Pin for DAC A Output Amplifier.
25	REFAB	External Reference Voltage Input for Channel A and Channel B. Reference input range is 1 V to 7 V. This pin programs the full-scale output voltage. $V_{REFIN} = 5 V$ for specified performance.
26	REFCD	External Reference Voltage Input for Channel C and Channel D. Reference input range is 1 V to 7 V. This pin programs the full-scale output voltage. $V_{REFIN} = 5 V$ for specified performance.
27, 29	NC	No Connect.
28	REFGND	Reference Ground Return for the Reference Generator and Buffers.
32	BIN/2sCOMP	This pin determines the DAC coding. This pin should be hardwired to either DV _{CC} or DGND. When the pin is hardwired to DV _{CC} , the input coding is offset binary. When the pin is hardwired to DGND, the input coding is twos complement.

TYPICAL PERFORMANCE CHARACTERISTICS











Figure 25. Source and Sink Capability of Output Amplifier with Positive Full Scale Loaded



Figure 26. Source and Sink Capability of Output Amplifier with Negative Full Scale Loaded



Figure 27. Full-Scale Settling Time



Figure 28. Major Code Transition Glitch Energy, $AV_{DD}/AV_{SS} = \pm 12 V$



Figure 29. Peak-to-Peak Noise (100 kHz Bandwidth)



Figure 31. Short-Circuit Current vs. RISCC



Figure 30. VOUT vs. AVDD/AVss on Power-Up

OUTLINE DIMENSIONS



Figure 32. 32-Lead Thin Plastic Quad Flat Package [TQFP] (SU-32-2) Dimensions shown in millimeters

ORDERING GUIDE

Model ¹	INL	Temperature Range	Package Description	Package Option
AD5764SSUZ-EP-RL7	±2 LSB max	–55°C to +105°C	32-Lead TQFP	SU-32-2

 1 Z = RoHS Compliant Part.

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